SUPPLEMENTARY INFORMATION

Spatially Nanoconfined N-type Polymer Semiconductors for Stretchable Ultrasensitive X-Ray Detection

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Section 1. Surface energies of the conjugated polymer and SEBS elastomer used in this study:

The water and diiodomethane contact angle of polymer semiconductor films were measured by the Drop Shape Analyzer (DSA100, KRÜSS) in static mode at room temperature. The obtained contact angle from the average of the left and right angles of a sessile drop was measured by KRÜSS software based on the tangential method. The de-ionized water and diiodomethane ($\approx 1 \mu L$) were dropped on the neat and hybrid semiconductor film, and then the droplet was snapshotted after the equilibrium on the gas-liquid-solid interface. The contact angle need to be fixed at the standard deviation of $\pm 0.5^{\circ}$.^{1, 2} The surface energy of polymer semiconductor films was calculated by the Owens-Wendt method equation³:

$$\gamma_s = \gamma_s^p + \gamma_s^d$$
$$(1 + \cos\theta_l)\gamma_l = 2(\sqrt{\gamma_l^d \gamma_s^d} + \sqrt{\gamma_l^p \gamma_s^p})$$

Where θ_l represents the contact angle of the testing liquid, including water and diiodomethane. Thereinto, γ_s , γ_s^p and γ_s^d are the total surface energy, polar component and dispersion component of the sample, respectively. The total surface energy (γ_l), dispersion component (γ_l^d) and polar component (γ_l^p) are 50.8 mJ m⁻², 50.42 mJ m⁻² and 0.38 mJ m⁻² for diiodomethane, and 72.8 mJ m⁻², 29.1 mJ m⁻² and 43.7 mJ m⁻² for water, respectively.



Supplementary Figure 1. Optical images of the snapshotted droplet showing the contact angels of the SEBS, FIID-CF₃TVT and nanoconfined hybrid polymer (70 wt% SEBS) films.

Supplementary Table 1. Surface energies of the SEBS, neat FIID-CF₃TVT and nanoconfined hybrid polymer (70 wt% SEBS) films.

Materials	Contact	angle (°)	Surface energy (mJ/m ²)			
	CH ₂ I ₂	H ₂ O	γ_s^d	γ_s^p	γ_s	
SEBS	53.5	110.8	32.5	1.21	33.71	
FIID- CF ₃ TVT	60.4	110.8	28.9	0.3	29.2	
Hybrid polymers	61.1	108.8	27.7	0.26	28.96	



Section 2. The spatial nanoconfinement effect on n-type hybrid polymer films:

Supplementary Figure 2. Morphology of the hybrid polymer films with different SEBS/FIID-CF₃TVT ratios, annealing temperatures and solvent types.



Supplementary Figure 3. Morphology of the hybrid polymer films with the SEBS contents of 50 wt% (a) and 70 wt% (b) at different spin-coating speeds.



Supplementary Figure 4. Characterization of the neat film and hybrid polymer films with different SEBS contents. (a) Ratios between S_{2p} peak and C_{1s} peak (S/C ratio) from XPS spectra at different depths of three hybrid films. (b) UV-vis spectrum of the neat and hybrid films.



Supplementary Figure 5. Two-dimensional GIXRD pattern of the neat FIID-CF₃TVT (a) and the hybrid polymer films with different SEBS contents of 30 wt% (b), 50 wt% (c) and 70 wt% (d).



Supplementary Figure 6. Experimental procedure of the soft contact lamination method to obtain both the top and bottom surface morphology of polymer films and the stretched films.



Supplementary Figure 7. Optical microscope images of the neat film and the hybrid polymer film with 70 wt% SEBS under 0%, 50% and 100% stretching strain. The scale bar is 20 μ m.

Section 3. The electronic performance of the OFETs fabricated on OTS-modified 300-nm SiO₂/Si wafer and the fully stretchable TFTs:

The mobility (μ), threshold voltage (V_{th}) and subthreshold swing (SS) are important parameters for evaluating the electronic performances of OFETs. These values can be extracted from the curve of the drain current (I_D) versus the gate voltage (V_G). In the saturation regime, the drain current (I_D) versus the gate voltage (V_G) according to the following equation⁴:

$$I_{DS} = \frac{W}{2L} C_i \mu_{sat} (V_G - V_{th})^2$$

Where W and L represent the channel length and width, respectively. C_i is the capacitance of the gate dielectric.

In details, the mobility is calculated by the slop of $\sqrt{|I_{DS}|}$ versus V_G according to the following equation⁵:

$$\mu_{sat} = \left(\frac{\partial \sqrt{|I_{DS}|}}{\partial V_G}\right)^2 \frac{2L}{WCl}$$
, applicable at $|V_G - V_{th}| < |V_{DS}|$

The V_{th} of the device is obtained by extrapolating a plot of $\sqrt{|I_{DS}|}$ versus V_G to I_{DS} = 0.

The subthreshold swing is defined as:

$$SS=d V_G/d (log I_{DS})$$



Supplementary Figure 8. The electronic performance of the hybrid polymer films fabricated on OTSmodified 300-nm SiO₂/Si wafer. (a) Schematic diagram of the OFET with a BGTC configuration. (b) Transfer curves ($V_{DS} = 60$ V) obtained from the neat film and the hybrid polymer film. (c) Output curves of the hybrid polymer film.



Supplementary Figure 9. Influence of the SEBS fraction on the mobility (a) and drain current (b) of the hybrid polymer films.



Supplementary Figure 10. Characterization of the hybrid polymer films prepared by the spin-coating (SC) method. (a) The polarized ultraviolet–visible absorption spectroscopy of the SC hybrid polymeric semiconductor film parallel and perpendicular to the radial coating direction. (b) GIWAXS images of the SC hybrid polymer film with the incident beam oriented parallel (left) and perpendicular (right) to the radial coating direction.



Supplementary Figure 11. Diagram illustrating the fabrication process of fully stretchable devices. The thickness of SEBS substrate can be altered from ~ 10 μ m (spin-coating method) to ~ 1 mm (drop-casting method) depending on the practical requirements. The thickness of the electrode is 30~40 nm. The thickness of the dielectric layer and semiconductor layer are 2000 nm and 100 nm, respectively.



Supplementary Figure 12. The electrical characterization of the fully stretchable transistor using the hybrid polymer semiconductor films prepared by the SC and OCSC methods.



Supplementary Figure 13. The real 'working lifetime' of the hybrid (a) and neat (b) semiconductor films when stored for 1day, 3 days and 1week.



Supplementary Figure 14. AFM phase images of the bottom surface morphology of the hybrid film prepared by the OCSC methods when stored for ~6 months.



Supplementary Figure 15. Transfer curves ($V_{DS} = 60$ V) of the STOFETs using OCSC hybrid polymer semiconductor films under different stretching strains and multiple stretch-release cycles. Transfer curves of the STOFETs at different stretching strains (a) parallel and (b) perpendicular to the charge transport direction. Transfer curves of the STOFETs under multiple stretching cycles at 25% strain, parallel to the charge transport direction at the released state (c) and at 25% strain (d).



Supplementary Figure 16. Transfer curves ($V_{DS} = 60 \text{ V}$) of the neat semiconductor films under different stretching strains along the charge transport direction (a) and perpendicular to the charge transport direction (b).



Supplementary Figure 17. Optical microscope and AFM phase images of the neat and hybrid films after multiple stretching-releasing cycles (up to 1000 cycles) at 25% strain.



Supplementary Figure 18. Capacitance of the dielectric layer (initial thickness, d = 2000 nm) as a function of the frequency.

Supplementary Table 2. Device geometry and dielectric parameters for the fully stretchable transistor under different strains.

Stretching direction	Strain(%)	Channel length(µm)	Channel width(µm)	Dielectric Thickness (nm)	Capacitance (nF/cm ²)
← Ⅲ → Channel length	0	200	4000	2000 ± 17	0.94
	25	250	3720	1690 ± 26	1.02
	50	300	3440	1530 ± 22	1.13
	75	350	3160	1410 ± 18	1.22
	100	400	2880	1380 ± 30	1.30
Channel width	0	200	4000	2000 ± 17	0.94
	25	186	5000	1690 ± 26	1.02
	50	172	6000	1530 ± 22	1.13
	75	158	7000	1410 ± 18	1.22
	100	144	8000	1380 ± 30	1.30

Section 4. The photosensitivity evaluation of the n-type hybrid polymer films for the X-ray detectors.

1. Calculation of sensitivity

The sensitivity including the sensitivity per unit area (S_A) and sensitivity per unit volume (S_V) , are defined as⁷:

$$S_A = \frac{I_{light} - I_{dark}}{DA}; \ S_V = \frac{I_{light} - I_{dark}}{DV}$$

where I_{light} and I_{dark} represent the photocurrent and dark current, respectively. D is the dose rate of X-ray irradiation, and A or V represents the active area or volume of the organic semiconductor exposed under the X-ray irradiation, respectively.

Typically, the detection sensitivity can be derived from the slope of the fitting linear of the current density versus different dose rates. The expression is as follows⁶:

$$S_A = \partial J / \partial D; S_V = S_A / d$$

where J is the current density and d is the thickness of active layer. The current density is defined as⁸⁻¹⁰:

$$J = \frac{I}{WL}$$

where I is the current. W and L represent the width and length of the channel, respectively.

2. Calculation of photoconductive gain

The expression of gain (G) is depicted as follows¹¹:

$$G = \frac{I_r}{I_t}$$

where I_r and I_t are the response current and theoretical current, respectively. The theoretical current is defined as¹²:

$$I_t = \phi nq$$

where Φ is the photon absorption rate, n is the number of the generated electron-hole pairs per absorbed photon, q is the elementary charge. It is noted that the total gain includes the photoconductive gain and impact ionization gain. To obtain the photoconductive gain, we consider n= E_{ph}/Δ , Δ =1.43 + 2E_g, where E_{ph} is the X-ray photon energy and E_g is the energy gap of FIID-CF₃TVT ($E_g \approx 2.1$ eV). As for the impact ionization gain, n is determined by the ratio of E_{ph} to E_g .

$$\phi = \frac{\epsilon \mathrm{Dm}_s}{E_{\mathrm{ph}}}$$

where ϵ is the fraction of absorbed photons, D is the dose rate, m_s is the sample mass.



Supplementary Figure 19. Attenuation efficiency as a function of film thickness for the Si wafer, neat SEBS, neat FIID-CF₃TVT and hybrid semiconductor film when subjected to 20 keV X-ray photons.



Supplementary Figure 20. Temporal response (a) and high-resolution temporal response (b) of the stretchable n-type hybrid semiconductor films at a X-ray dose rate of 3.5 μ Gy_{air} s⁻¹ at V_{DS} = 60V (V_G = 0 V).



Supplementary Figure 21. Temporal response of the stretchable n-type hybrid semiconductor films under several different dose rates from 37.7 to 141 nGy_{air} s⁻¹ at $V_{DS} = 60V$ ($V_G = 0$ V).



Supplementary Figure 22. Current density and photosensitivity as a function of X-ray dose rate for the hybrid polymer films at $V_{DS} = 60V (V_G = 0 V)$.



Supplementary Figure 23. Photoconductive gain as a function of X-ray dose rate for the hybrid polymer films at $V_{DS} = 60V$ ($V_G = 0$ V).



Supplementary Figure 24. Current density as a function of X-ray dose rate for the hybrid polymer films at $V_{DS} = 10V (V_G = 0 V)$.



Supplementary Figure 25. Temporal response of the air, insulated SEBS and hybrid semiconductor film under 3.5 μ Gy_{air} s⁻¹ dose rate at V_{DS} = 60V (V_G = 0 V).



Supplementary Figure 26. Transfer characteristics of the STOFETs in the dark and under different dose rate from 37.7 $nGy_{air} s^{-1}$ to 11.97 $mGy_{air} s^{-1}$ at $V_{DS} = 60V$.



Supplementary Figure 27. Temporal response of the hybrid polymer films with different SEBS contents under 3.5 μ Gy_{air} s⁻¹ dose rate at V_{DS} = 60V (V_G = 0 V).



Supplementary Figure 28. Performance comparison including the sensitivity (S_A) and detection limit of current reported X-ray detectors with our prepared stretchable X-ray detectors in this work. The detailed conditions are concluded in Supplementary Table 3 (the single red pentagram, at $V_{DS} = 10V$).



Supplementary Figure 29. Long-term response of the hybrid polymer film upon switching the X-ray irradiation on and off under 3.5 μ Gy_{air} s⁻¹ dose rate at V_{DS} = 60V (V_G = 0 V).



Supplementary Figure 30. Environmental stability of the initial hybrid polymer film and the polymer film stored for one week in air upon switching the X-ray irradiation on and off under 3.5 μ Gy_{air} s⁻¹ dose rate at V_{DS} = 60V (V_G = 0 V).



Supplementary Figure 31. Strain-tolerance behavior of the stretchable X-ray detectors with the hybrid polymer film under 3.5 μ Gy_{air} s⁻¹ dose rate at V_{DS} = 60V (V_G = 0 V).



Supplementary Figure 32. Temporal response of the hybrid polymer semiconductor films with different thicknesses under 3.5 μ Gy_{air} s⁻¹ dose rate at V_{DS} = 60V (V_G = 0 V).



Supplementary Figure 33. Photoelectrical stability of the stretchable X-ray detectors with the hybrid polymer film under 3.5 μ Gy_{air} s⁻¹ dose rate at V_{DS} = 60V (V_G = 0 V) after multiple stretching-releasing cycles (up to 1000 cycles) at 25% strain along the charge-transporting direction.



Supplementary Figure 34. GIWAXS images for the hybrid polymer film (a) and after 1000 stretch-release cycles (b) and line cuts along the Qxy axes (c).

Supplementary Table S3. Comparison in the performance of the prepared organic hybrid polymer with the previously reported X-ray photo-transistors.

		Operate		Minimum	SA	Sv	
The type of devices	Photoactive materials	Voltage (V)	X-ray source	dose rate (µC Gyair		$(\mu C G y_{air}^{-1})$	Re
				(mGy _{air} s ⁻¹)	cm ⁻²)	cm ⁻³)	f.
Indirect X-ray	Gd ₂ O ₃ :Eu ³⁺ :PPO:POP	V_G = -5 to -45,	G 40.1 V		(R=1.4	57 µA/W)	
detectors	OP/FS0096	V _{DS} = -45	Cu; 40 kV		(11 11 10 ; pa 2)		13
Direct X-ray detector based on heterojunction phototransistors	PDPPBTT/CsPbBrI2	V _G = -3,		1×10 ⁻⁶	~105	~10 ⁹ *	
		$V_{DS}=-30$	w; 20 keV				9
	P3HT/CsPbBrI2	V_{G} = -60,		1×10 ⁻⁶	~10 ⁵	~10 ⁹ *	1
		V_{DS} = -30	W; 20 keV	1 10	10	10	
	CsPbBr ₃ /DPP-	$V_G=0,$	Ag; 20 keV	7.9×10 ⁻⁵	$1.2 \times 10^{5*}$	1.2×10^{9}	14
	TT:SEBS	V_{DS} = -60					
	TIPGe-pentacene	V _G = -2,	Mo; 35 kV	6.4×10 ⁻³	18*	9.0×10 ⁵	8
Direct organic X- ray detectors		$V_{DS}=-3$					
	TIPS-pentacene:PS	$V_G=0,$	Mo; 35 kV	3.5×10 ⁻²	1.3×10 ⁴	3.2×10 ⁹	10
		V_{DS} = -20					
	TIPS-pentacene	V_{G} = -0.25,	Mo; 35 kV	6.5	53*	5.3×10 ⁶ *	15
		$V_{DS}=-3$					
Direct organic X-	FIID-CF3TVT:SEBS	$V_G=0,$	Ag; 20 keV	3.77×10 ⁻⁵	1.52×10^{4}	1.52×10 ⁹	This
ray detectors		$V_{DS}=60$					work

*Values extracted by the device information reported in the referenced papers.

Supplementary Table S4. Comparison in the performance of the prepared organic hybrid polymer with
the previously reported X-ray detectors using other materials and device structures.

			Operate	X-ray source	Minimu	SA	Sv	
The type of	Photoactive materials	Structure	Voltage	(anode	m dose	(µC Gy _{air} ⁻¹	(µC Gyair ⁻¹	Ref.
devices			(V)	voltage/X-ray	rate	cm ⁻²)	cm ⁻³)	
				energy)	(mGy _{air}			
					s ⁻¹)			
	MAPbBr _{3-x} Cl _x	Diode	-5	; 8keV	7.60×10-6	8.4×10 ⁴	3.5×10 ⁵	16
	(NH4)3Bi2I9	Resistance	10	Ag;50keV	5.50×10 ⁻⁵	803	5.33×10 ⁴	17
Perovskite	Cs2AgBiBr6	Resistance	50	W; 50kV	5.2×10 ⁻³	105	525	11
detectors	CsPbBr3	Diode	1.2	W; 50keV	3 ×10 ⁻²	5.57×10 ⁴	2.31×10 ⁶	18
	MAPbBr ₃	Diode	-1	Cu;	3.6×10 ⁻²	2.1×10 ⁴	1.05×10 ⁵	19
	MAPbI ₃	Resistance	10	Cu;8keV	0.928	650*	2.2×10 ⁶	20
Direct organic inorganic hybrid X-ray detectors	B2O3/P3HT:PCBM	Diode	-10	W; 50kV	0.13	4.79*	1.71×10 ³	21
	Ta/F8T2	Diode	-50	Mo;17.5keV	5	0.217*	434	22
	B ₂ O ₃ /PTAA	Diode	-100	Mo;17.5keV	13	0.15*	75	22
	PbS/P3HT:PCBM	Diode	-30	W; 40kV	10	3.66*	1219	23
Indirect organic inorganic hybrid X-ray detectors	GOS:Tb/P3HT:PCBM	Diode	-10	W; 70kV	1.5	7.35*	7300	24
	CsPbBr ₃ /P3HT:PCBM	Diode	-3	Cu; 40–80 kV	58.18	3.67	1837	25
	TIPS-pentacene	Resistance	0.1	Mo;17 keV	55	0.77*	7.7×10 ⁴	26
	PFO	Diode	-50	Mo; 50keV	4	0.96*	480	27
	MEH-PPV	Diode	-10	Mo; 50keV	4	0.48*	240	27
	РЗНТ	Diode	44		16.6	0.47*	154	28
Direct organic X-	FIID-CF3TVT:SEBS	Transistor	V _G =0,	Ag; 20 keV	3.77×10 ⁻⁵	1.52×10 ⁴	1.52×10 ⁹	This
ray detectors			V _{DS} =60			359	3.59×10 ⁷	WORK

*Values extracted by the device information reported in the referenced papers.

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